TOSHIBA Photocoupler GaAlAs Ired & Photo-Diode Array

TLP591B

Telecommunications Programmable Controllers MOS Gate Drivers MOSFET Gate Drivers

The TOSHIBA TLP591B consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a series-connected photo-diode array in a six-lead plastic DIP package. The TLP591B is suitable for MOS FET gate drivers. The TLP591B has an internal shunt resistor to optimize switching speed.

UL recognized: UL1577, file no. E67349

Absolute Maximum Ratings (Ta = 25°C)

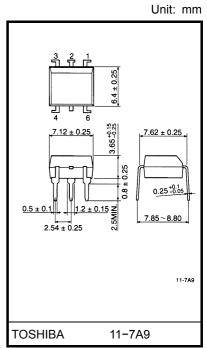
Characteristic		Symbol	Rating	Unit
	Forward current	ΙF	50	mA
LED	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA /°C
	Pulse forward current (100 µs pulse, 100 pps)	I _{FP}	1	Α
	Reverse voltage	V _R	3	V
	Junction temperature	Tj	125	°C
or	Forward current	I _{FD}	50	μΑ
Detector	Reverse voltage	V_{RD}	10	V
ă	Junction temperature	Tj	125	°C
Storage temperature range		T _{stg}	-55 to 125	°C
Operating temperature range		T _{opr}	-40 to 85	°C
Lead soldering temperature (10 sec.)		T _{sol}	260	°C
Isolation voltage (AC, 1 minute, R.H. ≤ 60%) (Note 1)		BVS	2500	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating

temperature/current/voltage, etc.) are within the absolute maximum ratings.

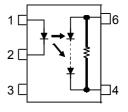
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Device considered a two terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.



Weight: 0.39 g (typ.)

Pin Configuration (top view)



1.: Anode(LED)

2. : Cathode(LED)

3.: NC

4. : Cathode

6.: Anode

Start of commercial production 1990/11

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	l _F	_	20	25	mA
Operating temperature	T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device.

Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V _F	I _F = 10 mA	1.2	1.4	1.7	V
LED	Reverse current	I _R	V _R = 3 V	_	_	10	μA
	Capacitance	C _T	V = 0V, f = 1 MHz		30	60	pF
Detector	Forward voltage	V _{FD}	I _{FD} = 10 μA		7	-	٧
Dete	Reverse current	I _{RD}	V _{RD} = 10 V	_	7	_	μA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Open voltage	V _{OC}	I _F = 20 mA	7	8	_	V
Short Current	Isc	I _F = 20 mA	24	40	_	μA

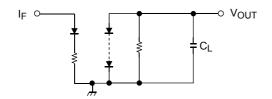
Isolation Characteristics (Ta = 25°C)

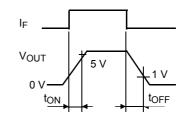
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance (input to output)	Cs	V _S = 0V, f = 1 MHz	_	8.0	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5×10 ¹⁰	10 ¹⁴	-	Ω
	BVS	AC, 1 minute	2500	_	1	\/rma
Isolation voltage		AC, 1 second, in oil	_	5000	_	Vrms
		DC, 1 minute, in oil	_	5000	_	Vdc

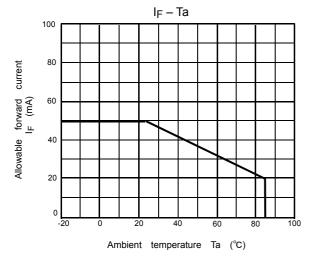
Switching Characteristics (Ta = 25°C)

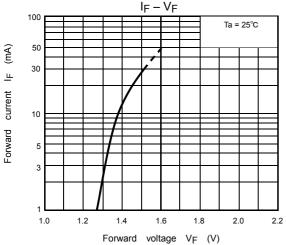
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	I _F = 20 mA, C _L = 1000 pF	-	0.2	-	ms
Turn-off time	toff	(Note 2)	_	3	_	ms

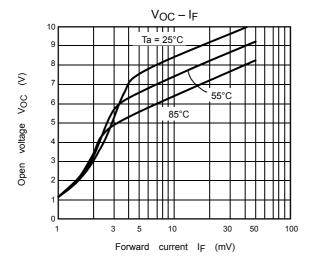
(Note 2) Switching time test circuit

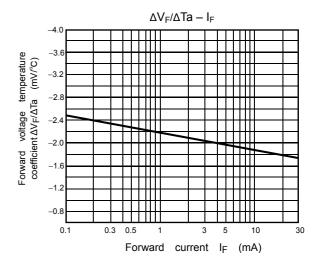


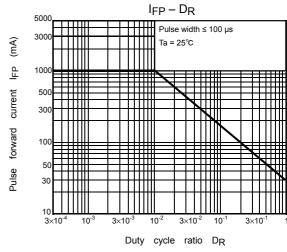


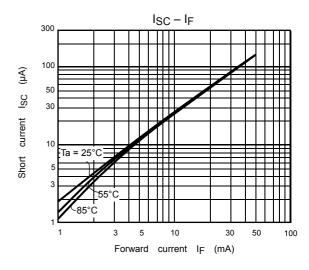












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